

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Jung Suk OH	05/19/2006
RECEIVING PARTY DATA	
Name:	SUNGBO INDUSTRIAL CO., LTD.
Street Address:	637-10 Sungkok-dong, Danwon-gu
City:	Ansan-city, Kyungki-do
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29247079
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	2015-06
NAME OF SUBMITTER:	James E. Bame
Total Attachments: 1 source=2015-06assignment_signed#page1.tif	

OP \$40.00 29247079

**ASSIGNMENT**

WHEREAS, I/WE, **JUNG SUK OH** residing at 637-10 Sungkok-dong, Danwon-dong, Ansan-city, Kyungki-do, Republic of Korea. hereafter, together with any successors, legal representatives or assigns thereof, referred to as "Applicant", invented certain new and useful improvements disclosed in an application for United States Letters Patent executed on even date herewith;

Titled: **"TOOTH POINT FOR EXCAVATOR BUCKET"**

Application Serial No. 29/247,079

Filed May 26, 2006

AND WHEREAS, **SUNGBO INDUSTRIAL CO., LTD.**, whose mailing address is 637-10 SUNGKOK-DONG, DANWON-GU, ANSAN-CITY, KYUNGKI-DO, hereafter, together with any successors, legal representatives or assigns thereof, referred to as "Assignee"), want(s) to acquire the entire right, title and interest in and to said improvements and application;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. Applicant has sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to Assignees the entire right, title and interest in and to said improvements, and said application and all divisions, substitutions, continuations and continuations-in-part thereof, and all United States Letters Patents (and all other patents) which may be granted thereon and all reissues and extensions thereof, and all priority rights under the International Convention for the Protection of Industrial Property for every member country, and all applications for patents (including related rights such as utility-model registrations, inventor's certificates, and the like) heretofore or hereafter filed for said improvements in any foreign countries, and all patents (including all extensions, renewals and reissues thereof) granted for said improvements in any foreign countries; and Applicant hereby authorize and request the United States Commissioner of Patents and Trademarks, and any officials of foreign countries whose duty is to issue patents on applications as aforesaid, to issue all patents for said improvements to Assignees in accordance with the terms of this assignment;

AND APPLICANT HEREBY covenants that Applicant has full right to convey the entire interest herein assigned, and that Applicant has not executed, and will not execute, any agreement in conflict herewith;

AND APPLICANT HEREBY further covenants and agrees that Applicant will communicate to Assignees any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional continuation, continuations legal proceeding, sign all lawful papers, execute all divisional, continuation, continuations-in-part, substitute and reissue applications, make all rightful oaths and generally do everything possible to aid Assignees to obtain and enforce proper patent protection for said improvements in all countries.

IN THE WITNESS WHEREOF, executed by the undersigned on this 19 day of May, 2006

Applicant: JUNG SUK OH

Signature: OH Jungsuk

STATE OF \_\_\_\_\_ )  
 \_\_\_\_\_ )  
 SS:

COUNTY OF \_\_\_\_\_ )

Before me personally appeared said JUNG SUK OH and acknowledged the foregoing instrument to be his free act and deed on this \_\_\_\_\_ day of \_\_\_\_\_, 2006.

Seal

**PATENT**